

L Number	Hits	Search Text	DB	Time stamp
1	547	438/459.ccls.	USPAT	2004/07/30 16:34
2	512	438/460.ccls.	USPAT	2004/07/30 16:34
3	456	438/462.ccls.	USPAT	2004/07/30 16:34
4	1548	438/692.ccls.	USPAT	2004/07/30 16:35
5	370	438/734.ccls.	USPAT	2004/07/30 16:35
6	407	438/753.ccls.	USPAT	2004/07/30 16:35
7	504	438/977.ccls.	USPAT	2004/07/30 16:35
8	485	204/298.12.ccls.	USPAT	2004/07/30 16:36
9	300	204/298.13.ccls.	USPAT	2004/07/30 16:36
10	1352	204/192.12.ccls.	USPAT	2004/07/30 16:43
11	262	204/192.23.ccls.	USPAT	2004/07/30 16:44
12	28	voutsas-apostolos\$.in. hartzell-john\$.in.	USPAT	2004/07/30 16:46
13	44	voutsas-apostolos\$.in. hartzell-john\$.in.	US-PGPUB	2004/07/30 16:45
14	17	voutsas-apostolos\$.in. hartzell-john\$.in.	EPO; JPO; DERWENT; IBM_TDB	2004/07/30 16:45
15	4470	(silicon and tile) and (shap\$6 cut\$6 etch\$6 treat\$6 polish\$6)	USPAT	2004/07/30 16:48
16	261	((silicon and tile) and (shap\$6 cut\$6 etch\$6 treat\$6 polish\$6)) and ((silicon same tile) same (shap\$6 cut\$6 etch\$6 treat\$6 polish\$6))	USPAT	2004/07/30 16:48
17	707	((silicon and tile) and (shap\$6 cut\$6 etch\$6 treat\$6 polish\$6)) and ((silicon same tile) and (shap\$6 cut\$6 etch\$6 treat\$6 polish\$6))	USPAT	2004/07/30 16:49
18	169	((silicon same tile) and (shap\$6 cut\$6 etch\$6 treat\$6 polish\$6))	US-PGPUB	2004/07/30 16:49
19	106	((silicon same tile) and (shap\$6 cut\$6 etch\$6 treat\$6 polish\$6))	EPO; JPO; DERWENT; IBM_TDB	2004/07/30 16:49